## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18 Stylesheet Version v18.0

Title of Invention

MULTI-RUN SELECTIVE PATTERN AND ETCH WAFER PROCESS

Application Number:

Confirmation Number:

First Named Applicant: K

Kenneth Bandy

Attorney Docket Number: BUR920020075US1

Search string:

( 6245581 or 6232134 or 5980766 or 5790254 or 5629772 ).pn.

## **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
$[\mathcal{V}]$	1	6245581	2001-06-12	Bonser et al.	]	438	8
W	2	6232134	2001-05-15	Farber et al.	]	438	9
$   \sqrt{1} $	3	5980766	1999-11-09	Flamm et all.	]	216	59
LV	4	5790254	1998-08-04	Ausschnitt	]	356	372
	5	5629772	1997-05-13	Ausschnitt	]	256	372

## Signature

Examiner Name	Date			
LAN VINH	2/14/05			

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